	A Pr Diodes	roduct Line of Incorporated	<b>P</b>	ERICOM	
SPECIFICAT	ΊΟΝ	FOR	APF	PROVAL	
CUSTOMER					
NOMINAL FREQUENCY		20.000000 MHz			
PRODUCT TYPE	TYP	PE FL 3.2x2	.5 SEAM	SEALED CRYSTA	
SPEC. NO. ( P/N )		FL2000044			
CUSTOMER P/N					
ISSUE DATE		January 18, 2018			
VERSION		C			
APPROVED	PRE	PARED		QA	
Brenda	Ke	lly		Dong Jang	
Diodes Incorporated No.2, Ziqiang 5th Rd., Zhongli Indus Zhongli Dist., Taoyuan City 32063, T TEL: 886-3-451-8888 FAX: 886-3-461-3865 https://www.diodes.com		S.) *	Pb-free RoHS Com HF-Haloger REACH Co	n Free	

### FL2000044

VER. C 18-Jan-18

### **VERSION HISTORY**

Version No.	Version Date	Description	Notes		
А	May.19,2009	Initial Release			
В	Jun.28,2011	Updated Suggested IR Reflow Profile & Format			
С	Jan.18,2018	Updated logo			



### FL2000044

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#### **ELECTRICAL SPECIFICATIONS**

Item	Symbol	Specifications	Units	Notes
Nominal Frequency	Fn	20.000000	MHz	
Mode of Oscillation	MO	AT Cut-Fundamental		
Calibration Load Capacitance	CL	18	pF	
Calibration Tolerance	n Tolerance FL ±10		ppm	at 25℃±3℃
Operating Temperature Range	TR	-40 to +85	C	
Frequency Stability (Frequency Deviation over the Operating Temperature Range)	F/T	±20	ppm	Reference to the Frequency at 25℃
Operating Drive Level		10	μW	
Maximum Drive Level		100	μW	
Equivalent Series Resistance	ESR	60	Ω	Max
Shunt Capacitance	C0	5	pF	Max
Aging at 25℃		±3	ppm	Max, 1st year
Storage Temperature		-55 to +125	C	
Insulation Resistance		500	MΩ	Min

This product doesn't include harmful substance that stipulated by SONY SS-00259 Level 1 and S-AT2-001 Level 1 standard. RoHS Compliant (Pb - Free).



### FL2000044

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Time

60~120 Sec 60~150 Sec

10 Sec

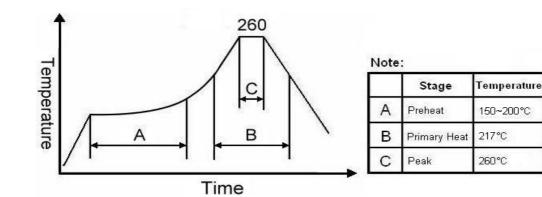
### **RELIABILITY SPECIFICATIONS**

#### **MECHANICAL AND ENVIRONMENTAL RATINGS:**

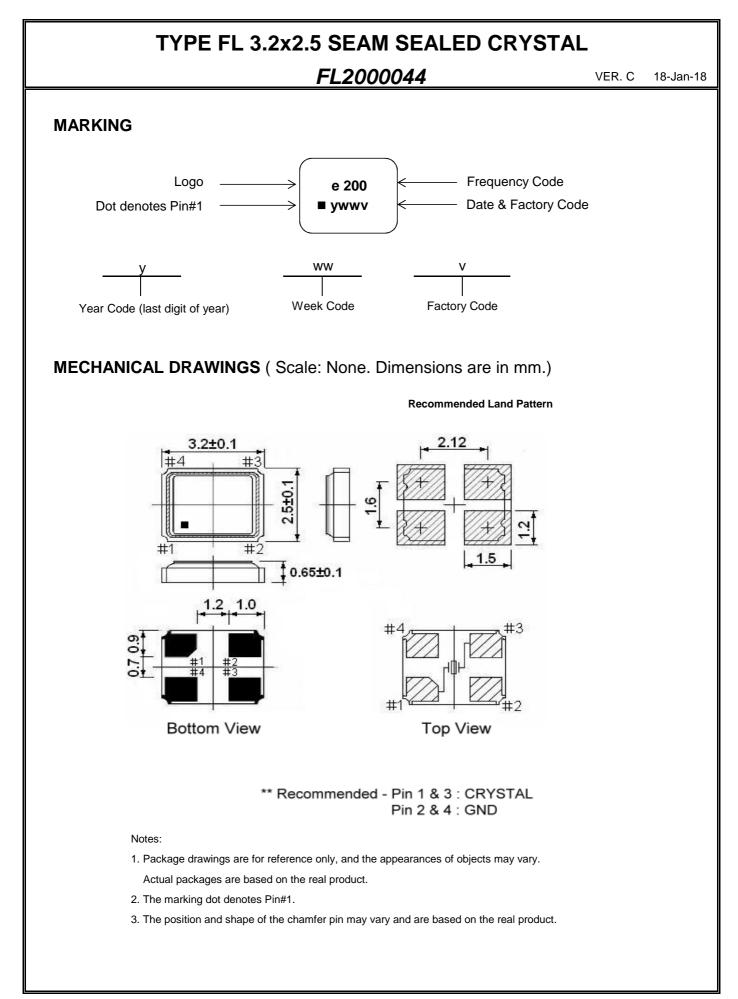
- a) FINE LEAK TEST: JESD22-A109 (Condition 1A)
- b) GROSS LEAK TEST: JESD22-A109 (Condition C)
- c) MOISTURE RESISTANCE: JESD22-A113
- d) SHOCK: JESD22-B104 (Condition B)
- e) SOLDERABILITY : (RoHS version): J-STD-002
- f) VIBRATION: JESD22-B103
- g) SOLVENT RESISTANCE: JESD22-B107
- h) RESISTANCE TO SOLDERING HEAT (RoHS version): J-STD-020D Table 5.2 Pb free devices (3 cycles max)

#### SUGGESTED IR REFLOW PROFILE

\*As per IPC-JEDEC J-STD-020D





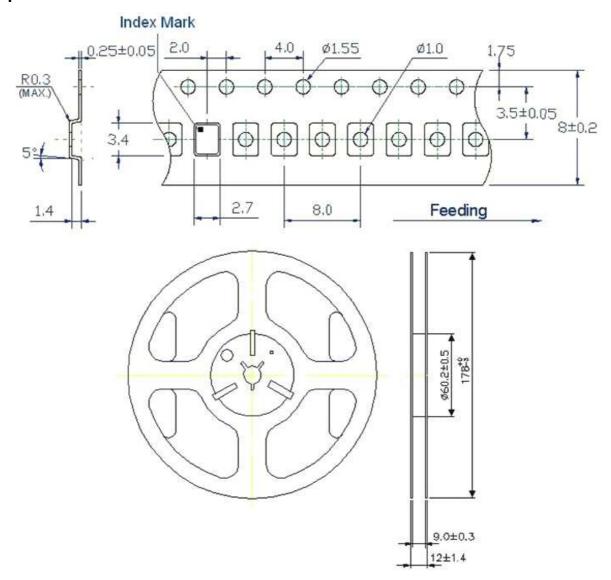




### FL2000044

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Tape & Reel



- 1. 230mm minimum leafer which consist of carrier and/or tape followed by a minimum of 160mm of empty carrier tape sealed with cover tape.
- 2. 160mm minimum trailer of empty carrier tape sealed with cover tape.



